AiT Semiconductor Inc.

DESCRIPTION

The AM3406 is the N-Channel logic enhancement mode power field effect transistor is produced using high cell density. Advanced trench technology to provide excellent R_{DS(ON)}.

This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, and low in-line power loss are needed in a very small outline surface mount package.

The AM3406 is available in SOT-23 Package.

ORDERING INFORMATION

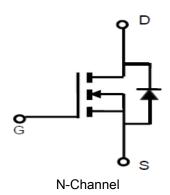
FEATURES

- 30V/6.0A, R_{DS(ON)} = 20mΩ(typ.) @V_{GS} = 10V
- 30V/4.8A, R_{DS(ON)} = 27mΩ(typ.) @V_{GS} = 4.5V
- Super high density cell design for extremely low RDS(ON)
- Exceptional on-resistance and Maximum DC current capability
- This is a Full Green compliance
- Available in SOT-23 Package

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- DSC
- LCD Display inverter
- Battery Powered System
- DC/DC Converter

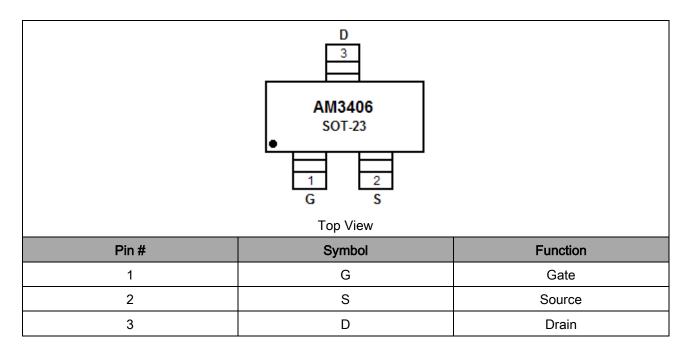
P CHANNEL MOSFET



Package Type	Part Number	
SOT-23	E3	AM3406E3R
301-23		AM3406E3VR
Note	R : Tape & Reel	
Note	V: Gree	n Package
AiT provides all Pb free products Suffix " V " means Green Package		



PIN DESCRIPTION





ABSOLUTE MAXIMUM RATINGS

$T_A = 25^{\circ}C$ unless otherwise noted			
V _{DSS} , Drain-Source Voltage		30\	
V _{GSS} , Gate-Source Voltage		±20V	
I _D , Continuous Drain Current (T _J =150°C)	V _{GS} = 10V	6.0A	
I _{DM} , Pulsed Drain Current		10A	
I _S , Continuous Source Current (Diode Conduction)		5.0A	
P _D , Power Dissipation			
$T_A = 25 \circ C$		1.25W	
T _A = 70°C		0.8W	
T _J , Operation Junction Temperature		150°C	
T _{STG} , Storage Temperature Range		-55°C ~ 150°C	

Stress beyond above listed "Absolute Maximum Ratings" may lead permanent damage to the device. These are stress ratings only and operations of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL DATA

Symbol	Parameter	Max	Unit
R _{0JA}	Thermal Resistance-Junction to Ambient	90	°C/W



ELECTRICAL CHARACTERISTICS

 T_A = 25°C unless otherwise noted

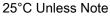
Parameter	Symbol	Conditions	Min	Тур.	Max	Units
Static Parameters						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250µA	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250µA	1.0	-	2.0	V
Gate Leakage Current	I _{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30V, V_{GS} = 0V$ $V_{DS} = 30V, V_{GS} = 0V$ $T_{J} = 55^{\circ}C$	-	-	1 5	μΑ
On-State Drain Current	Id(on)	$V_{DS} \ge -5V, V_{GS} = -4.5V$	10	-	-	A
		V _{GS} = 10V, I _D = 6.0A	-	20	26	
Drain-source On-Resistance	R _{DS(ON)}	V_{GS} = 4.5V, I _D = 4.8A	-	27	33	mΩ
Forward Transconductance	G _{fs}	V_{DS} = 15V, I_{D} = 5.0A	-	12	-	S
Source-Drain Doide						
Diode Forward Voltage	V _{SD}	I _S = 1.7A, V _{GS} = 0V	-	0.7	1.2	V
Dynamic Parameters						
Total Gate Charge	Qg	V _{DS} = 20V	-	6	-	
Gate-Source Charge	Qgs	V _{GS} = 4.5V	-	1.1	-	nC
Gate-Drain Charge	Q_{gd}	I _D = 5A	-	2.5	-	
Input Capacitance	Ciss		-	414	-	
Output Capacitance	Coss	V _{DS} = 15V V _{GS} = 0V f = 1MHz	-	60	-	
Reverse Transfer Capacitance	Crss		-	49	-	pF
Turn-On Time	t _{d(on)}	V _{DD} = 12V	-	7.5	-	
	tr	I _D = 5A	-	45	-	
Turn-Off Time	t _{d(off)}	V _{GS} = 10V	-	10	-	nS
	tf	R _G = 3Ω	-	4	-	

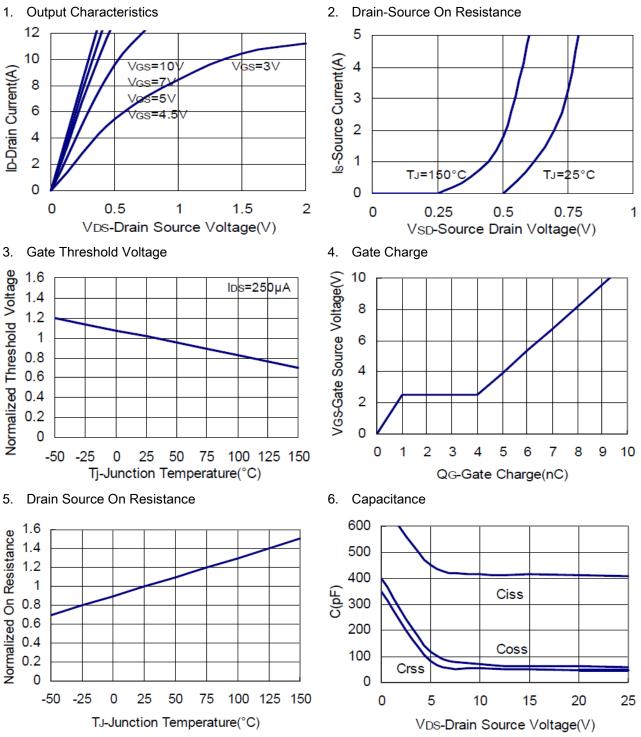
NOTE1: Pulse test: pulse width <= 300us, duty cycle<= 2%

NOTE2: Static parameters are based on package level with recommended wire-bonding



TYPICAL CHARACTERISTICS







7. Power Dissipation

0.1

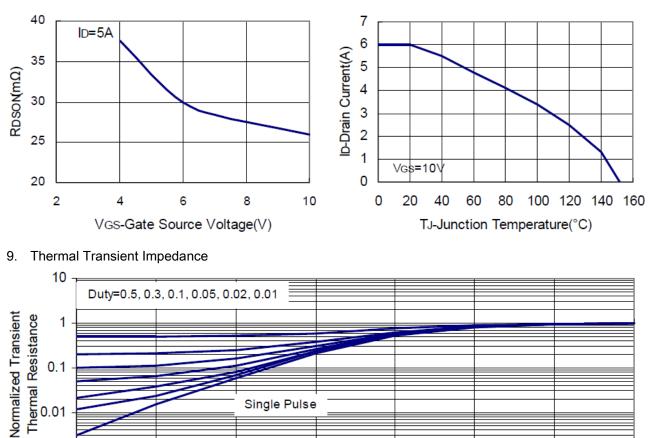
0.01

0.001

0.0001

0.001

8. Drain Current



Single Pulse

0.1

Square Wave Pulse Duration(Sec)

1

10

100

1000

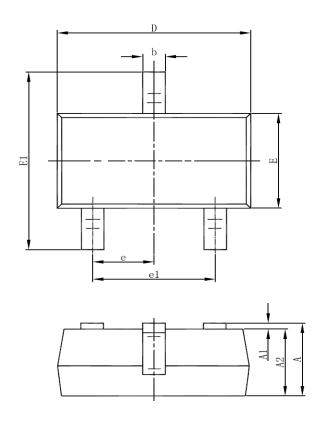
0.01



0.2

PACKAGE INFORMATION

Dimension in SOT-23 Package (Unit: mm)



SYMBOL	MIN	MAX	
A	1.050	1.250	
A1	0.000	0.100	
A2	1.050	1.150	
b	0.300	0.500	
с	0.100	0.200	
D	2.820	3.020	
E	1.500	1.700	
E1	2.650	2.950	
е	0.950(BSC)		
e1	1.800	2.000	
L	0.300	0.600	
θ	0°	8°	



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